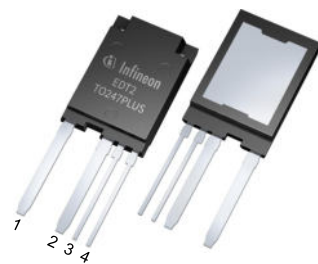


## Final datasheet

### Duo Pack EDT2™ IGBT and emitter controlled diode in TO247PLUS package

#### Features

- $V_{CE} = 750\text{ V}$
- $I_C = 160\text{ A}$
- Suitable for  $470\text{ V } V_{DC}$  systems and increased overvoltage margin for  $400\text{ V } V_{DC}$  systems
- Very low  $V_{CEsat}$  (C-KE) =  $1.22\text{ V}$  (typ.) at  $I_{Cnom} = 160\text{ A}$ ,  $25^\circ\text{C}$
- Up to 40% less System  $R_{th}$  due to reflow capability, increased power output
- 30% Less Turn On Energy loss compared to 3 pin devices due to Kelvin emitter
- Short circuit robust  $t_{sc} = 3\text{ }\mu\text{s}$  at  $V_{CE} = 470\text{ V}$ ,  $V_{GE} = 15\text{ V}$
- Self limiting current under short circuit condition
- Positive thermal coefficient and very tight parameter distribution for easy paralleling
- Excellent current sharing in parallel operation
- Smooth switching characteristics
- Low gate charge  $Q_G$
- Simple gate driver design
- Co-packed with fast soft recovery emitter controlled diode (Emcon3)
- Low EMI signature
- TO247PLUS package with high creepage distance  $6.6\text{ mm}$
- High reliability and operating lifetime, proven power cycling sec. robustness
- Wide Power pins ( $2\text{ mm}$ ) for high current busbar
- Resistive weldable pins for direct busbar connections
- Lead-free plated pins and back



Halogen-free



RoHS



#### Potential applications

- xEV traction inverter
- DC-link discharge switch
- Automotive aux-drives

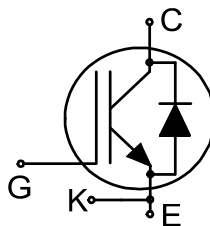
#### Product validation

- Qualified according to AEC-Q101 for automotive applications
- Qualified Reflow device  $260^\circ\text{C}$  according to JEDEC J-STD-020 MSL2

#### Description

Package pin definition:

- Pin C (1) & backside - collector
- Pin E (2) - emitter
- Pin K (3) - Kelvin emitter
- Pin G (4) - gate



| Type           | Package             | Marking   |
|----------------|---------------------|-----------|
| AIKYX160N75CP2 | PG-TO247-4-PLUS-WT7 | AKYX16FCP |

Table of contents

|   |                                |    |
|---|--------------------------------|----|
|   | Description .....              | 1  |
|   | Features .....                 | 1  |
|   | Potential applications .....   | 1  |
|   | Product validation .....       | 1  |
|   | Table of contents .....        | 2  |
| 1 | Package .....                  | 3  |
| 2 | IGBT .....                     | 3  |
| 3 | Diode .....                    | 5  |
| 4 | Characteristics diagrams ..... | 7  |
| 5 | Package outlines .....         | 16 |
| 6 | Testing conditions .....       | 17 |
|   | Revision history .....         | 18 |
|   | Disclaimer .....               | 19 |

**1 Package**

## 1 Package

**Table 1** Characteristic values

| Parameter                               | Symbol        | Note or test condition                               | Values |      |                    | Unit |
|-----------------------------------------|---------------|------------------------------------------------------|--------|------|--------------------|------|
|                                         |               |                                                      | Min.   | Typ. | Max.               |      |
| Internal emitter inductance             | $L_E$         | simulated starting from L2 at 1 MHz                  |        | 3.7  |                    | nH   |
| Collector-emitter loop inductance       | $L_{CE}$      | simulated starting from L2 at 1 MHz                  |        | 6.2  |                    | nH   |
| Main emitter pin resistance             | $R_E$         | Simulated starting from L2 at 10 kHz                 |        | 0.37 |                    | mΩ   |
| Storage temperature                     | $T_{stg}$     |                                                      | -55    |      | 150                | °C   |
| Soldering temperature                   | $T_{sold}$    | reflow soldering (MSL2 according to JEDEC J-STD-020) |        |      | 260                | °C   |
| Thermal resistance, junction-ambient    | $R_{th(j-a)}$ |                                                      |        | 40   |                    | K/W  |
| IGBT thermal resistance, junction-case  | $R_{th(j-c)}$ |                                                      |        | 0.15 | 0.2 <sup>1)</sup>  | K/W  |
| Diode thermal resistance, junction-case | $R_{th(j-c)}$ |                                                      |        | 0.28 | 0.36 <sup>1)</sup> | K/W  |

1) Defined by simulation, not subject to production test

## 2 IGBT

**Table 2** Maximum rated values

| Parameter                                              | Symbol       | Note or test condition                                                                                                                                                |                       | Values | Unit |
|--------------------------------------------------------|--------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|--------|------|
| Collector-emitter voltage                              | $V_{CE}$     | $T_{vj} \geq 25\text{ °C}$                                                                                                                                            |                       | 750    | V    |
| DC collector current, limited by $T_{vjmax}$           | $I_C$        |                                                                                                                                                                       | $T_c = 25\text{ °C}$  | 200    | A    |
|                                                        |              |                                                                                                                                                                       | $T_c = 100\text{ °C}$ | 160    |      |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$ | $I_{Cpulse}$ |                                                                                                                                                                       |                       | 480    | A    |
| Turn-off safe operating area                           |              | $V_{CE} \leq 750\text{ V}, T_{vj} \leq 175\text{ °C}$                                                                                                                 |                       | 480    | A    |
| Gate-emitter voltage                                   | $V_{GE}$     |                                                                                                                                                                       |                       | ±20    | V    |
| Transient gate-emitter voltage                         | $V_{GE}$     | $t_p = 10\text{ μs}, D < 0.01$                                                                                                                                        |                       | ±30    | V    |
| Short-circuit withstand time <sup>1)</sup>             | $t_{SC}$     | $V_{CC} \leq 470\text{ V}, V_{GE} = -8/15\text{ V}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0\text{ s}, T_{vj} = 25\text{ °C}$ |                       | 3      | μs   |
| Power dissipation                                      | $P_{tot}$    | $T_{vj} = 175\text{ °C}$                                                                                                                                              | $T_c = 25\text{ °C}$  | 750    | W    |
|                                                        |              |                                                                                                                                                                       | $T_c = 100\text{ °C}$ | 375    |      |

1) Measured with kelvin emitter for driving

**Table 3**                      **Characteristic values**

| Parameter                                   | Symbol             | Note or test condition                                                                                                                                                                                       |                                                   | Values |       |      | Unit |
|---------------------------------------------|--------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------|--------|-------|------|------|
|                                             |                    |                                                                                                                                                                                                              |                                                   | Min.   | Typ.  | Max. |      |
| Collector-emitter saturation voltage        | $V_{CEsat}$        | $I_C = 160 \text{ A}$ , $V_{GE} = 15 \text{ V}$                                                                                                                                                              | $T_{vj} = 25 \text{ °C}$                          | 1.2    | 1.37  | 1.55 | V    |
|                                             |                    |                                                                                                                                                                                                              | $T_{vj} = 175 \text{ °C}$                         |        | 1.6   |      |      |
| Collector-Kelvin emitter saturation voltage | $V_{CEsat} (C-KE)$ | $I_C = 160 \text{ A}$ , $V_{GE} = 15 \text{ V}$                                                                                                                                                              | $T_{vj} = 25 \text{ °C}$                          |        | 1.22  |      | V    |
| Gate-emitter threshold voltage              | $V_{GETh}$         | $I_C = 2.15 \text{ mA}$ , $V_{CE} = V_{GE}$                                                                                                                                                                  |                                                   | 5.2    | 5.8   | 6.4  | V    |
| Zero gate-voltage collector current         | $I_{CES}$          | $V_{CE} = 750 \text{ V}$ , $V_{GE} = 0 \text{ V}$                                                                                                                                                            | $T_{vj} = 25 \text{ °C}$                          |        |       | 200  | μA   |
|                                             |                    |                                                                                                                                                                                                              | $T_{vj} = 175 \text{ °C}$                         |        | 8     |      | mA   |
| Gate-emitter leakage current                | $I_{GES}$          | $V_{CE} = 0 \text{ V}$ , $V_{GE} = 20 \text{ V}$                                                                                                                                                             |                                                   |        |       | 100  | nA   |
| Transconductance                            | $g_{fs}$           | $I_C = 160 \text{ A}$ , $V_{CE} = 20 \text{ V}$                                                                                                                                                              |                                                   |        | 117   |      | S    |
| Short-circuit collector current             | $I_{SC}$           | $V_{CC} \leq 470 \text{ V}$ , $V_{GE} = -8/15 \text{ V}$ , $t_{SC} \leq 3 \text{ μs}$ , Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0 \text{ s}$ , $T_{vj} = 25 \text{ °C}$ |                                                   |        | 1500  |      | A    |
| Input capacitance                           | $C_{ies}$          | $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 100 \text{ kHz}$                                                                                                                                     |                                                   |        | 17280 |      | pF   |
| Output capacitance                          | $C_{oes}$          | $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 100 \text{ kHz}$                                                                                                                                     |                                                   |        | 443   |      | pF   |
| Reverse transfer capacitance                | $C_{res}$          | $V_{CE} = 25 \text{ V}$ , $V_{GE} = 0 \text{ V}$ , $f = 100 \text{ kHz}$                                                                                                                                     |                                                   |        | 79    |      | pF   |
| Gate charge                                 | $Q_G$              | $V_{CC} = 600 \text{ V}$ , $I_C = 160 \text{ A}$ , $V_{GE} = -8/15 \text{ V}$                                                                                                                                |                                                   |        | 975   |      | nC   |
| Turn-on delay time                          | $t_{d(on)}$        | $V_{CC} = 470 \text{ V}$ , $V_{GE} = -8/15 \text{ V}$ , $R_{G(on)} = 5 \text{ Ω}$ , $L_\sigma = 20 \text{ nH}$ , $C_\sigma = 15 \text{ pF}$                                                                  | $T_{vj} = 25 \text{ °C}$ , $I_C = 160 \text{ A}$  |        | 64    |      | ns   |
|                                             |                    |                                                                                                                                                                                                              | $T_{vj} = 175 \text{ °C}$ , $I_C = 160 \text{ A}$ |        | 64    |      |      |
| Rise time (inductive load)                  | $t_r$              | $V_{CC} = 470 \text{ V}$ , $V_{GE} = -8/15 \text{ V}$ , $R_{G(on)} = 5 \text{ Ω}$ , $L_\sigma = 20 \text{ nH}$ , $C_\sigma = 15 \text{ pF}$                                                                  | $T_{vj} = 25 \text{ °C}$ , $I_C = 160 \text{ A}$  |        | 35    |      | ns   |
|                                             |                    |                                                                                                                                                                                                              | $T_{vj} = 175 \text{ °C}$ , $I_C = 160 \text{ A}$ |        | 43    |      |      |
| Turn-off delay time                         | $t_{d(off)}$       | $V_{CC} = 470 \text{ V}$ , $V_{GE} = -8/15 \text{ V}$ , $R_{G(on)} = 5 \text{ Ω}$ , $L_\sigma = 20 \text{ nH}$ , $C_\sigma = 15 \text{ pF}$                                                                  | $T_{vj} = 25 \text{ °C}$ , $I_C = 160 \text{ A}$  |        | 234   |      | ns   |
|                                             |                    |                                                                                                                                                                                                              | $T_{vj} = 175 \text{ °C}$ , $I_C = 160 \text{ A}$ |        | 315   |      |      |
| Fall time (inductive load)                  | $t_f$              | $V_{CC} = 470 \text{ V}$ , $V_{GE} = -8/15 \text{ V}$ , $R_{G(on)} = 5 \text{ Ω}$ , $L_\sigma = 20 \text{ nH}$ , $C_\sigma = 15 \text{ pF}$                                                                  | $T_{vj} = 25 \text{ °C}$ , $I_C = 160 \text{ A}$  |        | 57    |      | ns   |
|                                             |                    |                                                                                                                                                                                                              | $T_{vj} = 175 \text{ °C}$ , $I_C = 160 \text{ A}$ |        | 121   |      |      |

**(table continues...)**

**Table 3** (continued) Characteristic values

| Parameter                      | Symbol    | Note or test condition                                                                                                                                      | Values                                                             |      |      | Unit               |
|--------------------------------|-----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------|------|------|--------------------|
|                                |           |                                                                                                                                                             | Min.                                                               | Typ. | Max. |                    |
| Turn-on energy <sup>1)</sup>   | $E_{on}$  | $V_{CC} = 470 \text{ V}$ , $V_{GE} = -8/15 \text{ V}$ ,<br>$R_{G(on)} = 5 \text{ } \Omega$ , $L_{\sigma} = 20 \text{ nH}$ ,<br>$C_{\sigma} = 15 \text{ pF}$ | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 160 \text{ A}$  | 5.5  |      | mJ                 |
|                                |           |                                                                                                                                                             | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 160 \text{ A}$ | 7.7  |      |                    |
| Turn-off energy                | $E_{off}$ | $V_{CC} = 470 \text{ V}$ , $V_{GE} = -8/15 \text{ V}$ ,<br>$R_{G(on)} = 5 \text{ } \Omega$ , $L_{\sigma} = 20 \text{ nH}$ ,<br>$C_{\sigma} = 15 \text{ pF}$ | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 160 \text{ A}$  | 4.9  |      | mJ                 |
|                                |           |                                                                                                                                                             | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 160 \text{ A}$ | 8.8  |      |                    |
| Total switching energy         | $E_{ts}$  | $V_{CC} = 470 \text{ V}$ , $V_{GE} = -8/15 \text{ V}$ ,<br>$R_{G(on)} = 5 \text{ } \Omega$ , $L_{\sigma} = 20 \text{ nH}$ ,<br>$C_{\sigma} = 15 \text{ pF}$ | $T_{vj} = 25 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 160 \text{ A}$  | 10.4 |      | mJ                 |
|                                |           |                                                                                                                                                             | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ ,<br>$I_C = 160 \text{ A}$ | 16.5 |      |                    |
| Operating junction temperature | $T_{vj}$  |                                                                                                                                                             | -40                                                                |      | 175  | $^{\circ}\text{C}$ |

1) includes IGBT losses caused by the reverse recovery current

**Note:** Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified.

### 3 Diode

**Table 4** Maximum rated values

| Parameter                                          | Symbol       | Note or test condition                    |                                      | Values | Unit |
|----------------------------------------------------|--------------|-------------------------------------------|--------------------------------------|--------|------|
| Repetitive peak reverse voltage                    | $V_{RRM}$    | $T_{vj} \geq 25 \text{ }^{\circ}\text{C}$ |                                      | 750    | V    |
| Diode forward current, limited by $T_{vjmax}$      | $I_F$        | $T_c = 25 \text{ }^{\circ}\text{C}$       |                                      | 200    | A    |
|                                                    |              | $T_c = 100 \text{ }^{\circ}\text{C}$      |                                      | 160    |      |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$ | $I_{Fpulse}$ |                                           |                                      | 480    | A    |
| Power dissipation                                  | $P_{tot}$    | $T_{vj} = 175 \text{ }^{\circ}\text{C}$   | $T_c = 25 \text{ }^{\circ}\text{C}$  | 417    | W    |
|                                                    |              |                                           | $T_c = 100 \text{ }^{\circ}\text{C}$ | 208    |      |

**Table 5** Characteristic values

| Parameter             | Symbol | Note or test condition |                                         | Values |      |      | Unit |
|-----------------------|--------|------------------------|-----------------------------------------|--------|------|------|------|
|                       |        |                        |                                         | Min.   | Typ. | Max. |      |
| Diode forward voltage | $V_F$  | $I_F = 160 \text{ A}$  | $T_{vj} = 25 \text{ }^{\circ}\text{C}$  | 1.6    | 1.8  | 2    | V    |
|                       |        |                        | $T_{vj} = 175 \text{ }^{\circ}\text{C}$ |        | 1.85 |      |      |

(table continues...)

**Table 5** (continued) Characteristic values

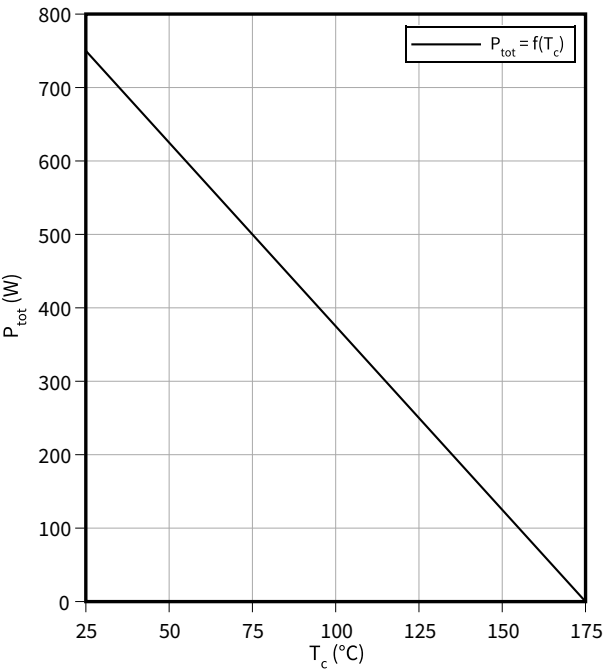
| Parameter                           | Symbol    | Note or test condition                                                             |                                                                                                   | Values |       |      | Unit          |
|-------------------------------------|-----------|------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------|--------|-------|------|---------------|
|                                     |           |                                                                                    |                                                                                                   | Min.   | Typ.  | Max. |               |
| Diode reverse recovery charge       | $Q_{rr}$  | $V_R = 470 \text{ V}$                                                              | $T_{vj} = 25 \text{ °C}$ ,<br>$I_F = 160 \text{ A}$ ,<br>$-di_F/dt = 3996 \text{ A/}\mu\text{s}$  |        | 5.5   |      | $\mu\text{C}$ |
|                                     |           |                                                                                    | $T_{vj} = 175 \text{ °C}$ ,<br>$I_F = 160 \text{ A}$ ,<br>$-di_F/dt = 3425 \text{ A/}\mu\text{s}$ |        | 14    |      |               |
| Diode peak reverse recovery current | $I_{rrm}$ | $V_R = 470 \text{ V}$                                                              | $T_{vj} = 25 \text{ °C}$ ,<br>$I_F = 160 \text{ A}$ ,<br>$-di_F/dt = 3996 \text{ A/}\mu\text{s}$  |        | 68.7  |      | A             |
|                                     |           |                                                                                    | $T_{vj} = 175 \text{ °C}$ ,<br>$I_F = 160 \text{ A}$ ,<br>$-di_F/dt = 3425 \text{ A/}\mu\text{s}$ |        | 108.1 |      |               |
| Reverse recovery energy             | $E_{rec}$ | $V_R = 470 \text{ V}$ , $L_\sigma = 20 \text{ nH}$ ,<br>$C_\sigma = 15 \text{ pF}$ | $T_{vj} = 25 \text{ °C}$ ,<br>$I_F = 160 \text{ A}$ ,<br>$-di_F/dt = 3996 \text{ A/}\mu\text{s}$  |        | 2.1   |      | mJ            |
|                                     |           |                                                                                    | $T_{vj} = 175 \text{ °C}$ ,<br>$I_F = 160 \text{ A}$ ,<br>$-di_F/dt = 3425 \text{ A/}\mu\text{s}$ |        | 4.9   |      |               |
| Operating junction temperature      | $T_{vj}$  |                                                                                    |                                                                                                   | -40    |       | 175  | °C            |

**Note:** For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

4 Characteristics diagrams

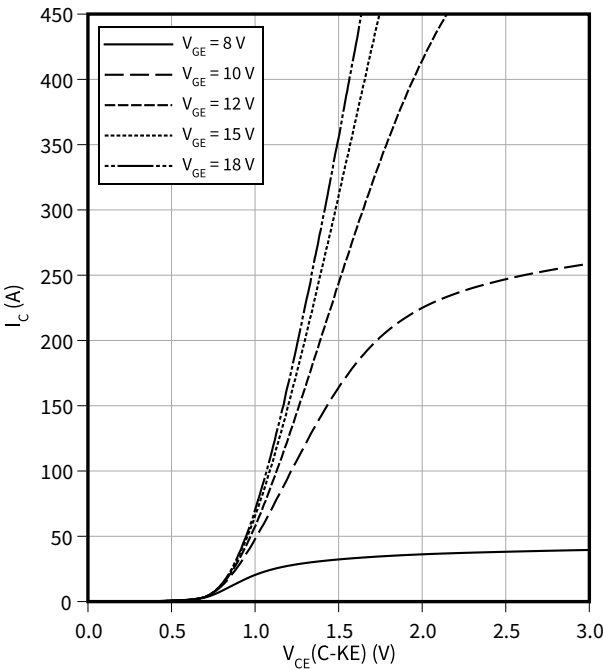
Power dissipation as a function of case temperature

$P_{\text{tot}} = f(T_c)$   
 $T_{vj} \leq 175\text{ °C}$



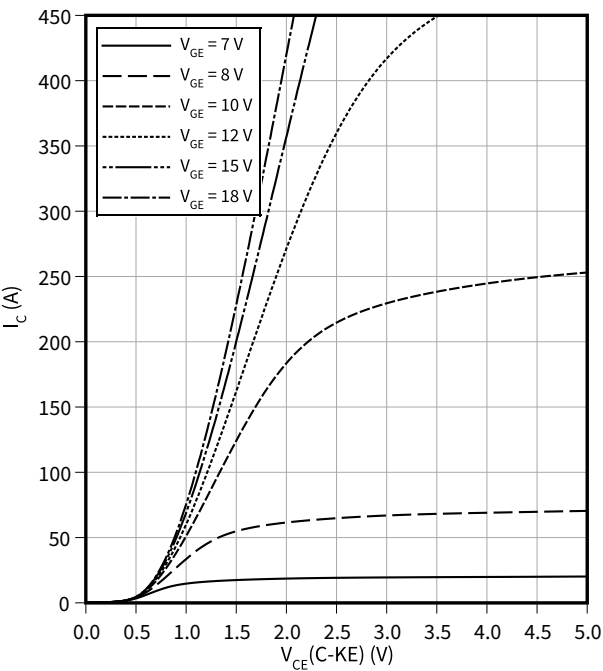
Typical output characteristic

$I_C = f(V_{CE}(C-KE))$   
 $T_{vj} = 25\text{ °C}$



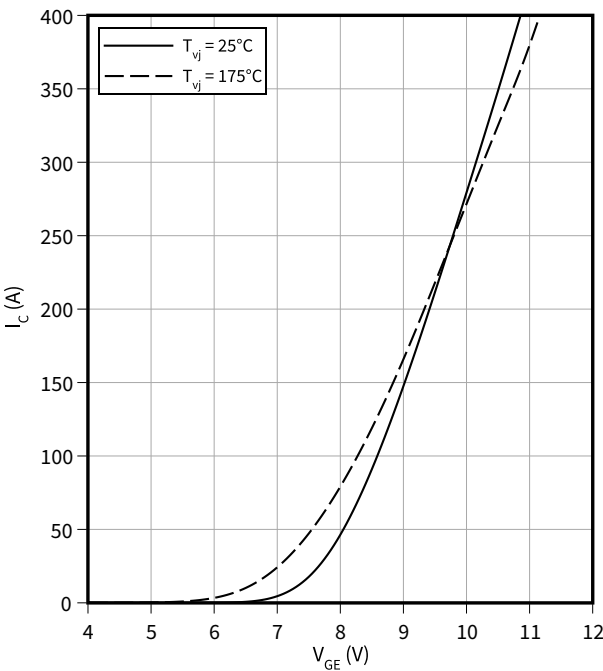
Typical output characteristic

$I_C = f(V_{CE}(C-KE))$   
 $T_{vj} = 175\text{ °C}$



Typical transfer characteristic

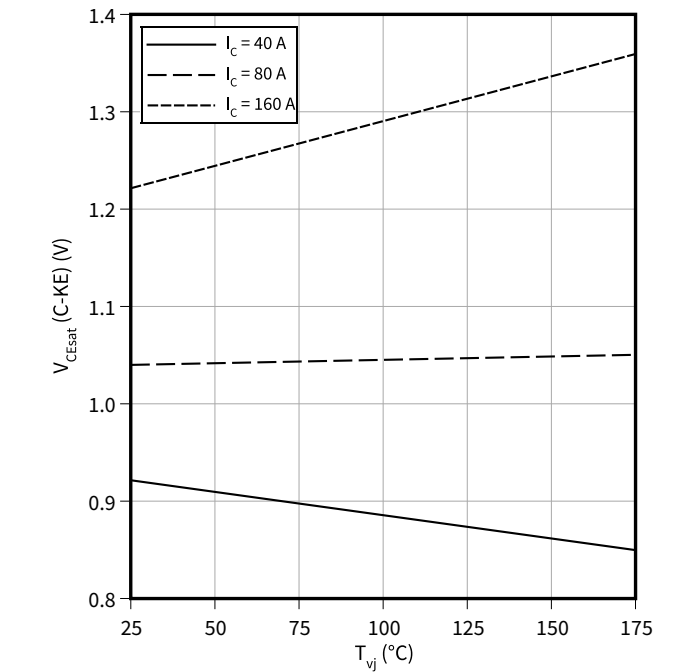
$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



4 Characteristics diagrams

Typical collector-Kelvin emitter saturation voltage as a function of junction temperature

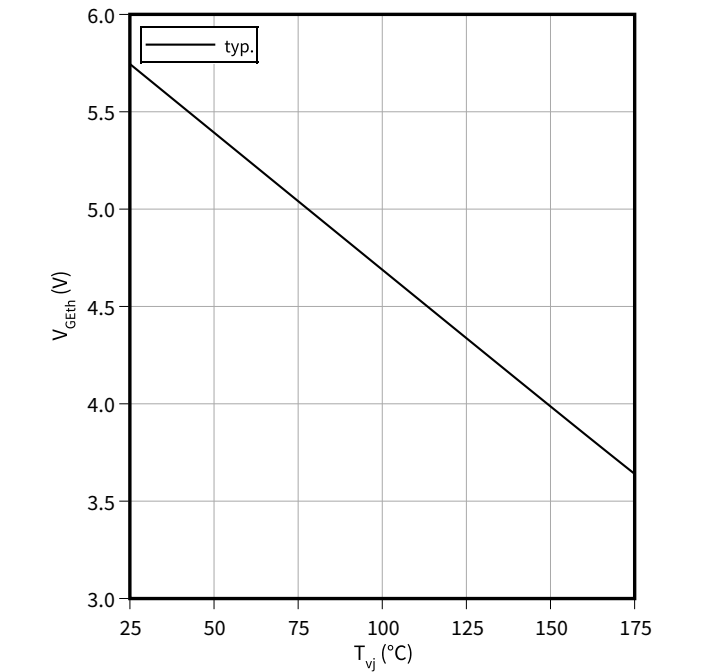
$V_{CEsat} (C-KE) = f(T_{vj})$



Gate-emitter threshold voltage as a function of junction temperature

$V_{GEth} = f(T_{vj})$

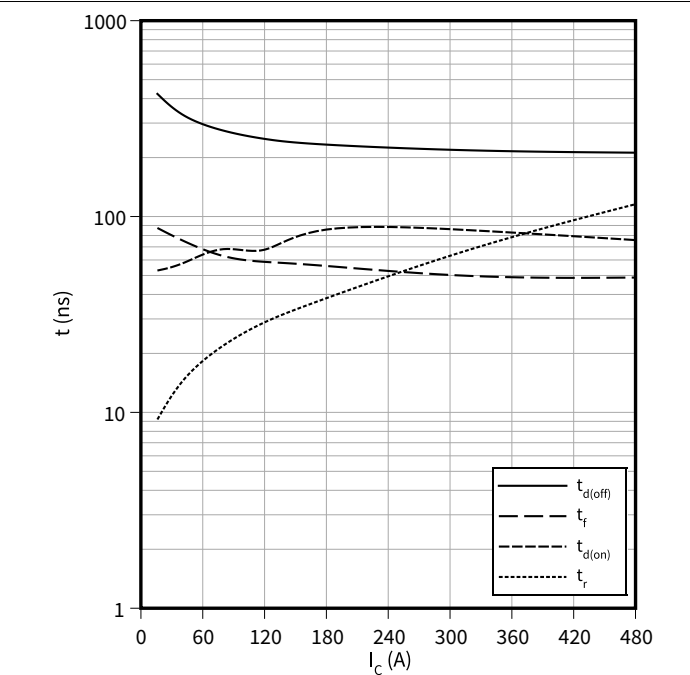
$I_C = 2.15$  mA



Typical switching times as a function of collector current

$t = f(I_C)$

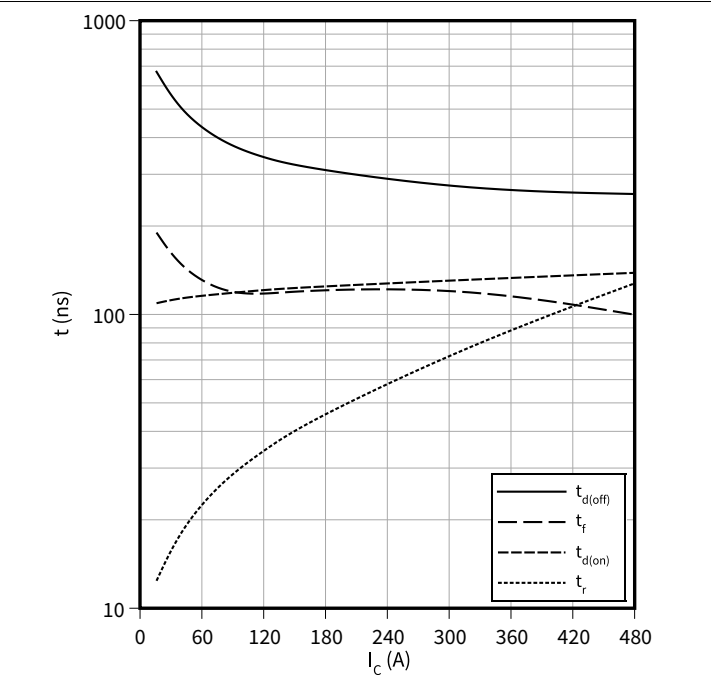
$V_{CC} = 470$  V,  $T_{vj} = 25$  °C,  $R_G = 5$   $\Omega$



Typical switching times as a function of collector current

$t = f(I_C)$

$V_{CC} = 470$  V,  $T_{vj} = 175$  °C,  $R_G = 5$   $\Omega$

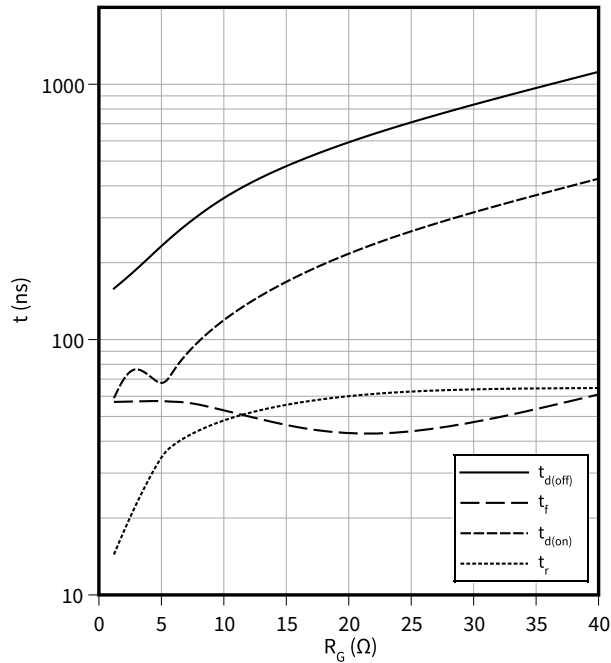


4 Characteristics diagrams

Typical switching times as a function of gate resistor

$t = f(R_G)$

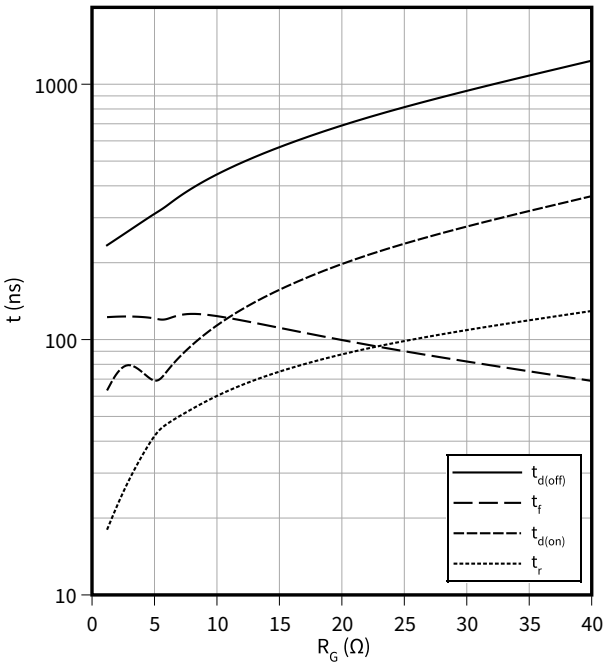
$I_C = 160\text{ A}$ ,  $V_{CC} = 470\text{ V}$ ,  $T_{vj} = 25\text{ °C}$



Typical switching times as a function of gate resistor

$t = f(R_G)$

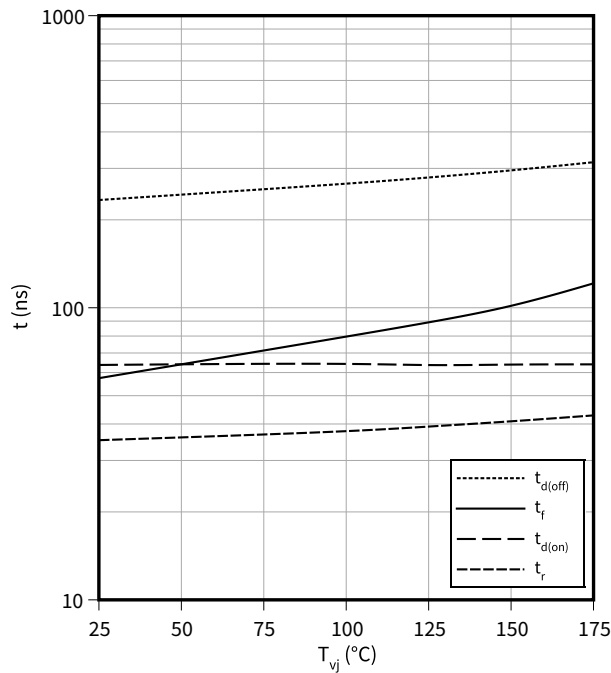
$I_C = 160\text{ A}$ ,  $V_{CC} = 470\text{ V}$ ,  $T_{vj} = 175\text{ °C}$



Typical switching times as a function of junction temperature

$t = f(T_{vj})$

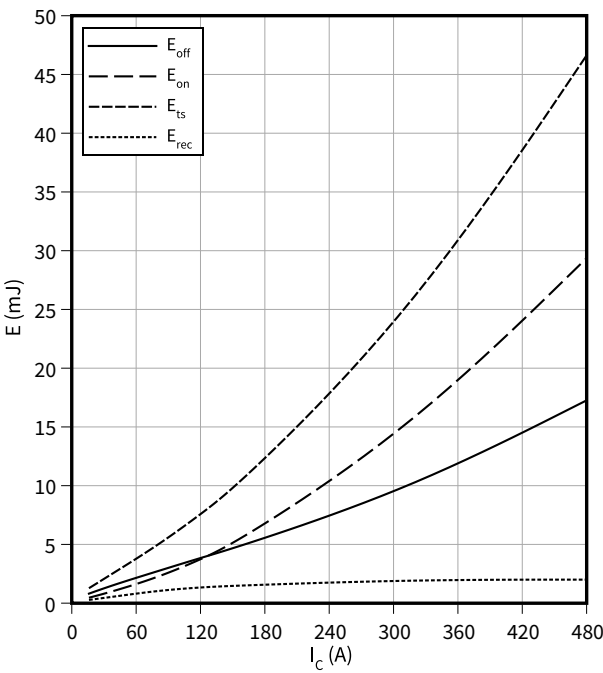
$I_C = 160\text{ A}$ ,  $V_{CC} = 470\text{ V}$ ,  $R_G = 5\text{ }\Omega$



Typical switching energy losses as a function of collector current

$E = f(I_C)$

$V_{CC} = 470\text{ V}$ ,  $T_{vj} = 25\text{ °C}$ ,  $R_G = 5\text{ }\Omega$

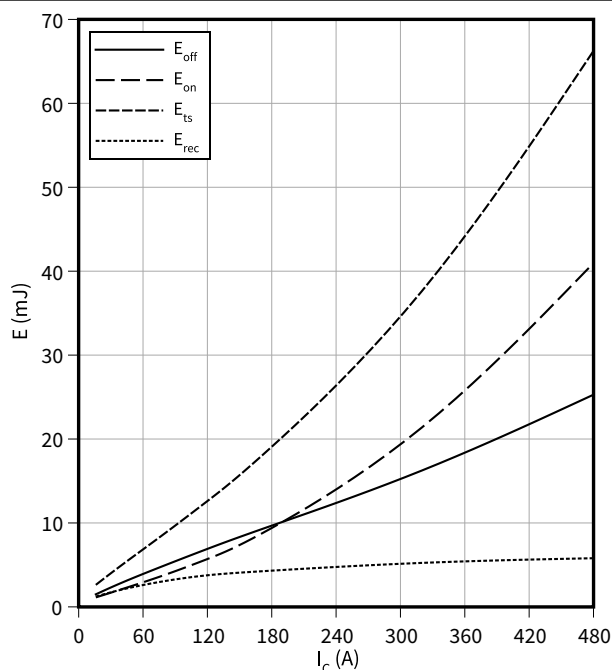


4 Characteristics diagrams

**Typical switching energy losses as a function of collector current**

$$E = f(I_C)$$

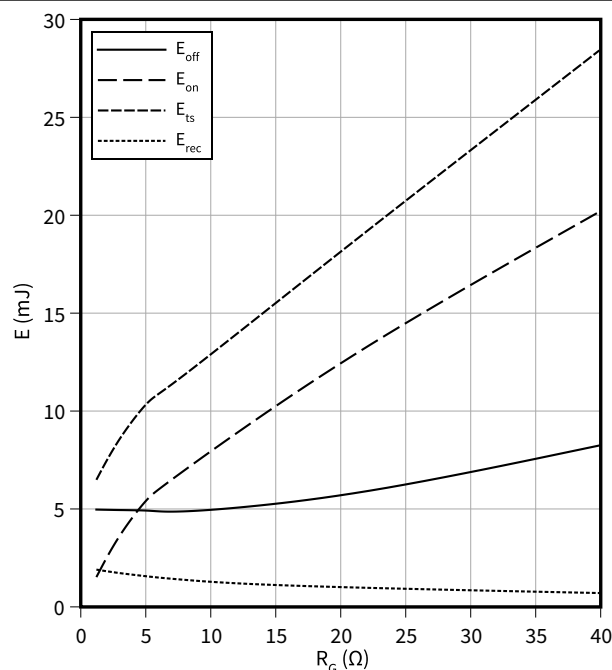
$V_{CC} = 470 \text{ V}$ ,  $T_{vj} \geq 25 \text{ °C}$ ,  $R_G = 5 \text{ } \Omega$



**Typical switching energy losses as a function of gate resistor**

$$E = f(R_G)$$

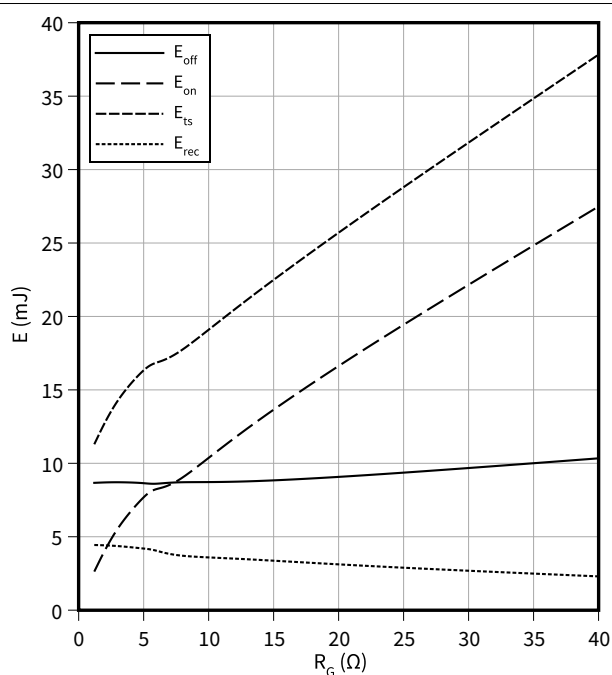
$I_C = 160 \text{ A}$ ,  $V_{CC} = 470 \text{ V}$ ,  $T_{vj} = 25 \text{ °C}$



**Typical switching energy losses as a function of gate resistor**

$$E = f(R_G)$$

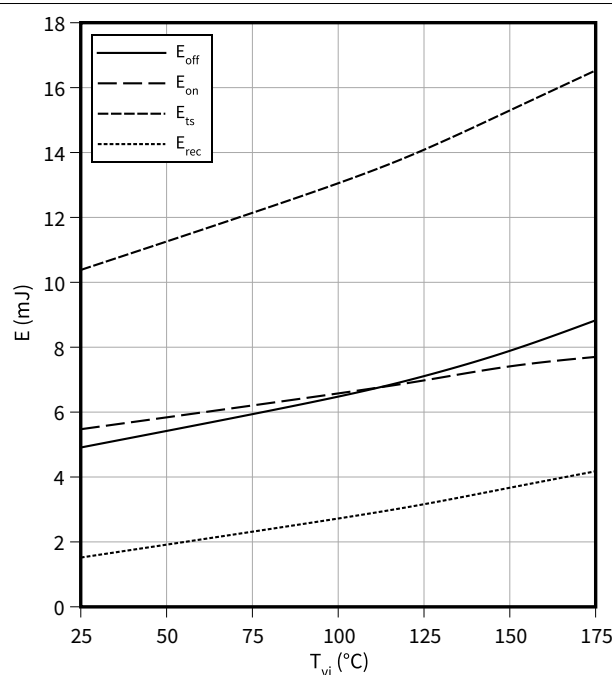
$I_C = 160 \text{ A}$ ,  $V_{CC} = 470 \text{ V}$ ,  $T_{vj} = 175 \text{ °C}$



**Typical switching energy losses as a function of junction temperature**

$$E = f(T_{vj})$$

$I_C = 160 \text{ A}$ ,  $V_{CC} = 470 \text{ V}$ ,  $R_G = 5 \text{ } \Omega$

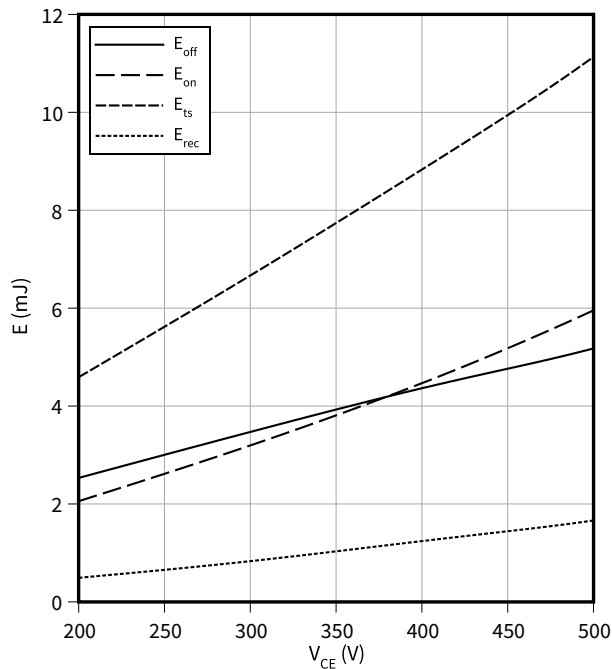


**4 Characteristics diagrams**

**Typical switching energy losses as a function of collector emitter voltage**

$$E = f(V_{CE})$$

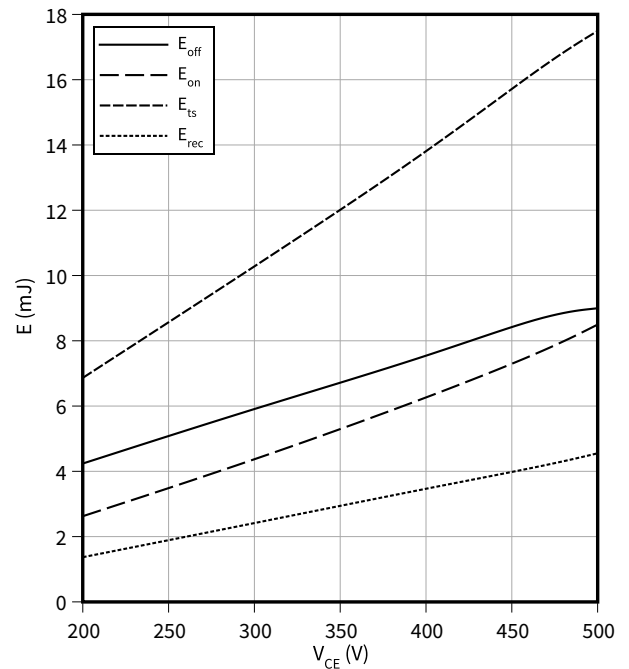
$I_C = 160 \text{ A}$ ,  $T_{vj} = 25 \text{ °C}$ ,  $R_G = 5 \text{ } \Omega$



**Typical switching energy losses as a function of collector emitter voltage**

$$E = f(V_{CE})$$

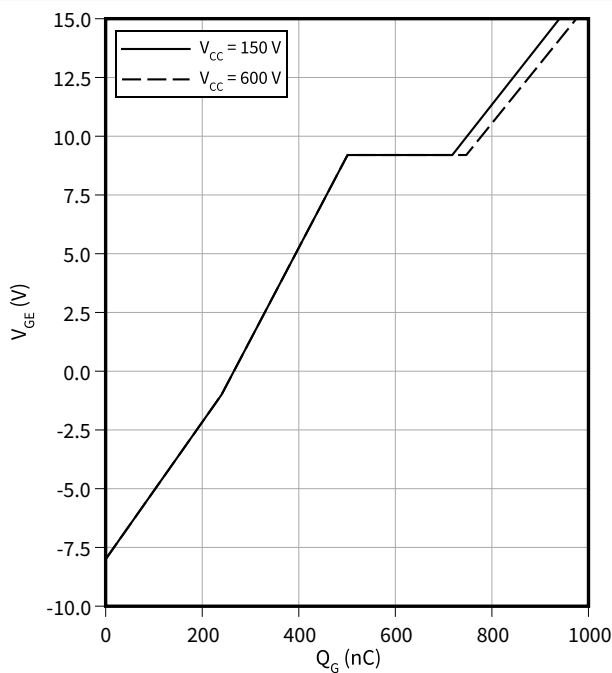
$I_C = 160 \text{ A}$ ,  $T_{vj} = 175 \text{ °C}$ ,  $R_G = 5 \text{ } \Omega$



**Typical gate charge**

$$V_{GE} = f(Q_G)$$

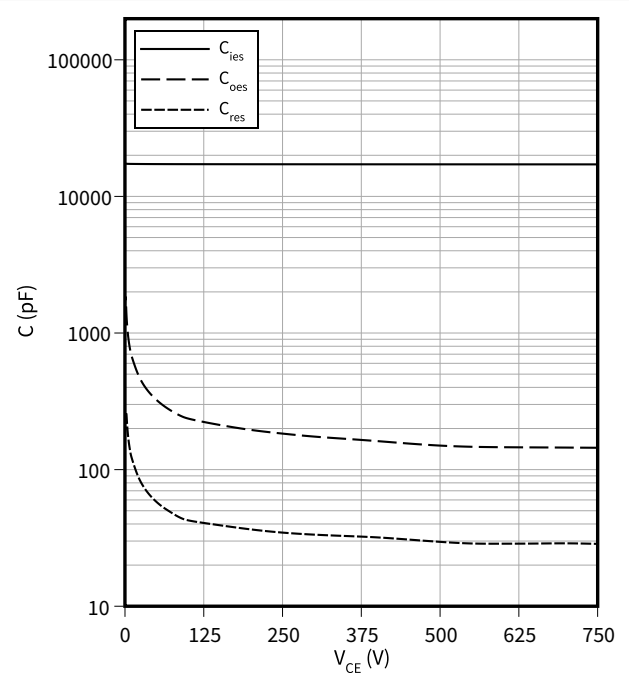
$I_C = 160 \text{ A}$



**Typical capacitance as a function of collector-emitter voltage**

$$C = f(V_{CE})$$

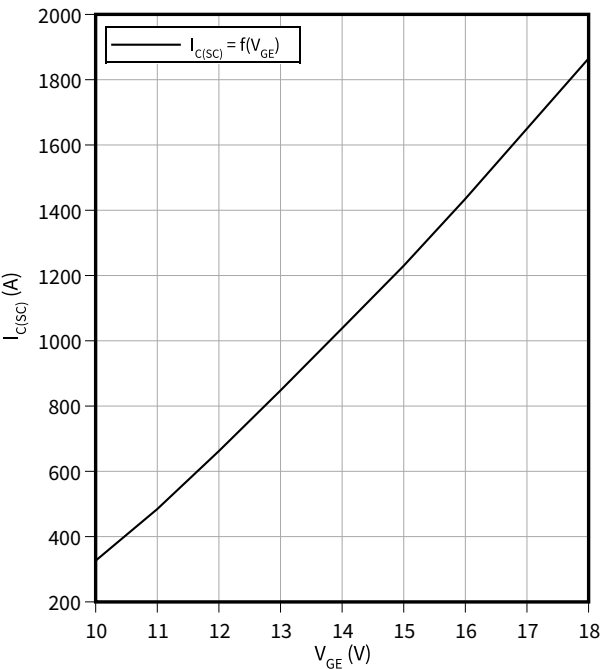
$f = 100 \text{ kHz}$



4 Characteristics diagrams

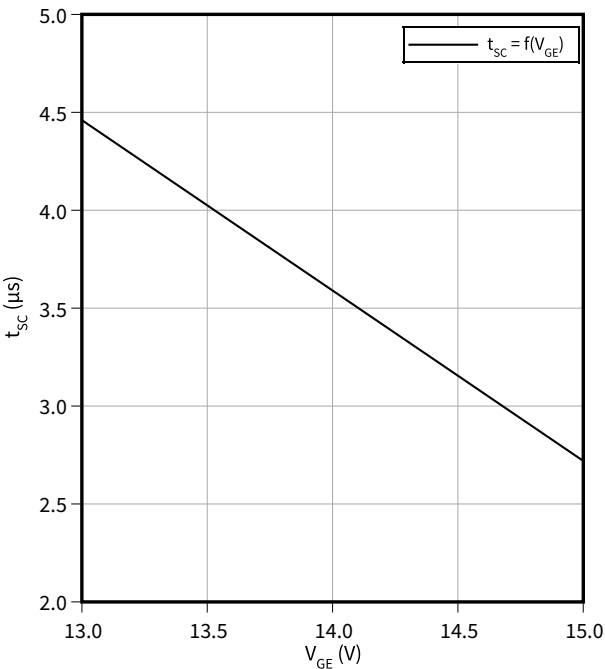
Typical short circuit collector current as a function of gate-emitter voltage

$I_{C(SC)} = f(V_{GE})$   
 $T_{vj} = 175\text{ °C}, V_{CC} = 470\text{ V}$



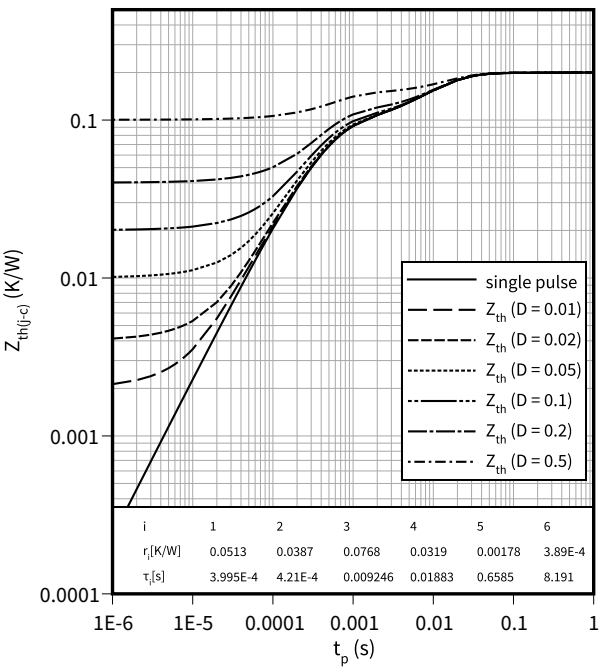
Short circuit withstand time as a function of gate-emitter voltage

$t_{SC} = f(V_{GE})$   
 $T_{vj} = 175\text{ °C}, V_{CC} = 470\text{ V}$



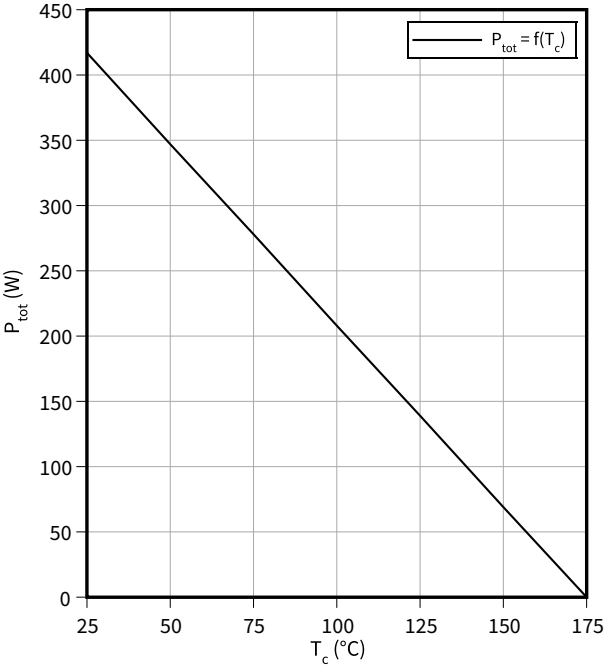
IGBT transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$   
 $D = t_p/T$



Power dissipation as a function of case temperature

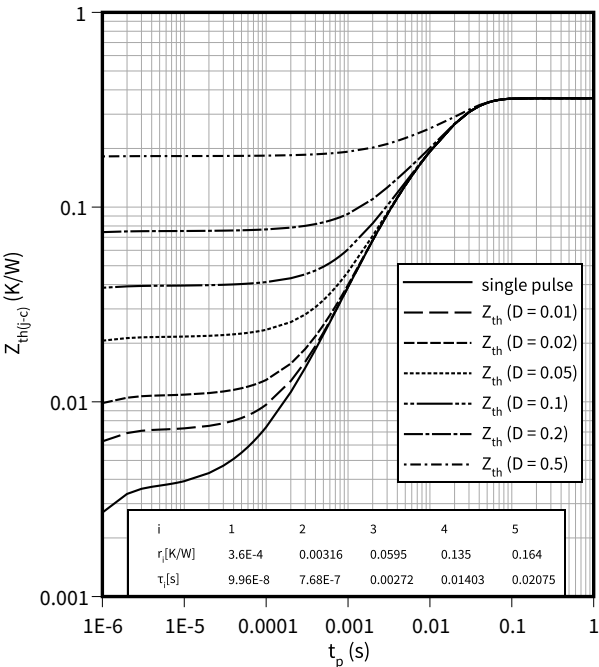
$P_{tot} = f(T_c)$   
 $T_{vj} \leq 175\text{ °C}$



4 Characteristics diagrams

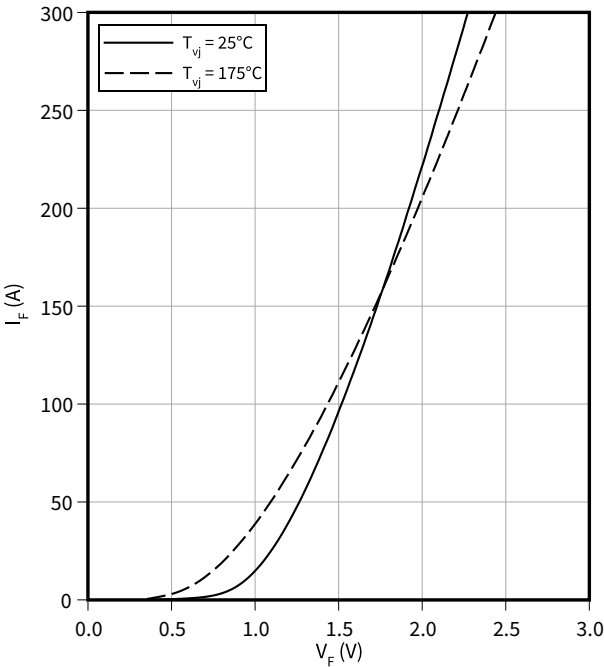
Diode transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$   
 $D = t_p/T$



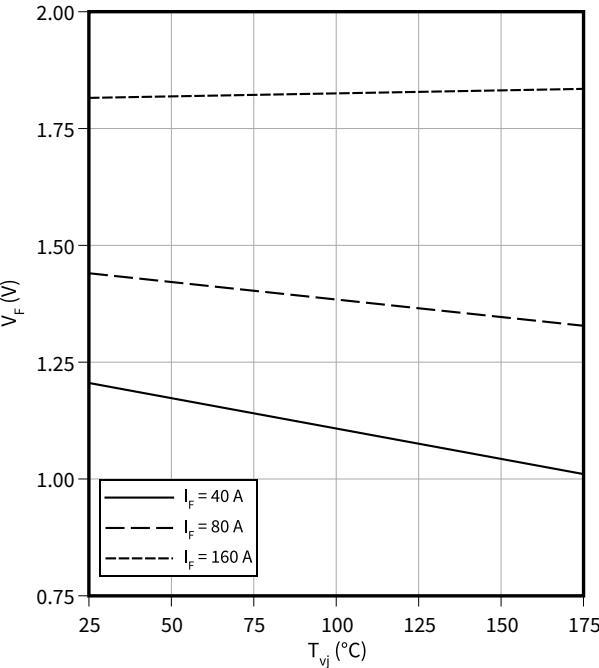
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



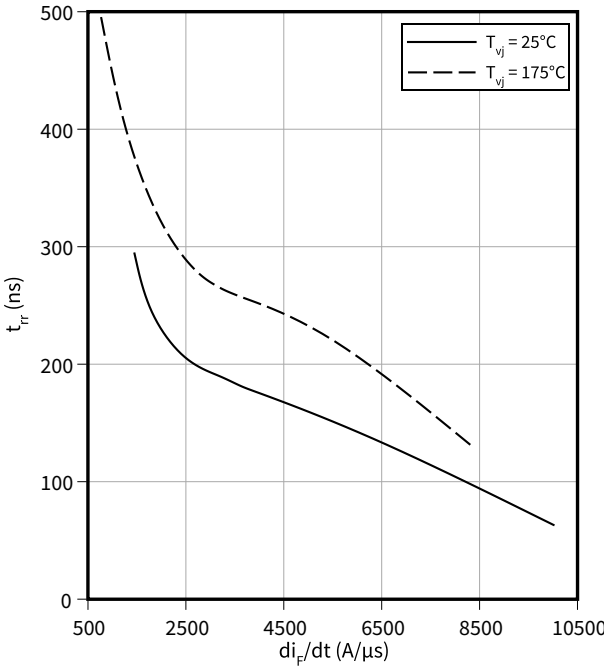
Typical diode forward voltage as a function of junction temperature

$V_F = f(T_{vj})$

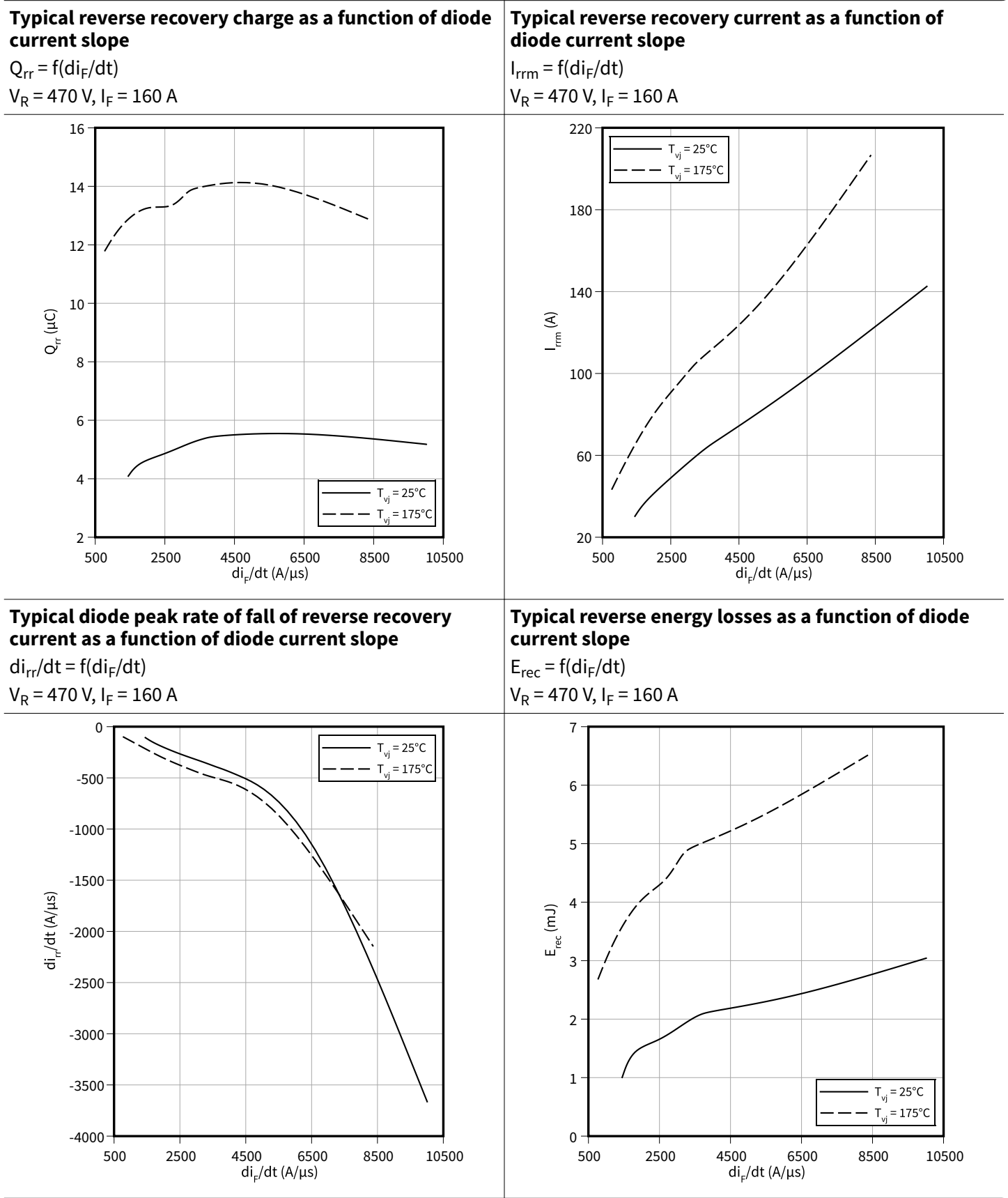


Typical reverse recovery time as a function of diode current slope

$t_{rr} = f(di_F/dt)$   
 $V_R = 470 \text{ V}, I_F = 160 \text{ A}$



4 Characteristics diagrams

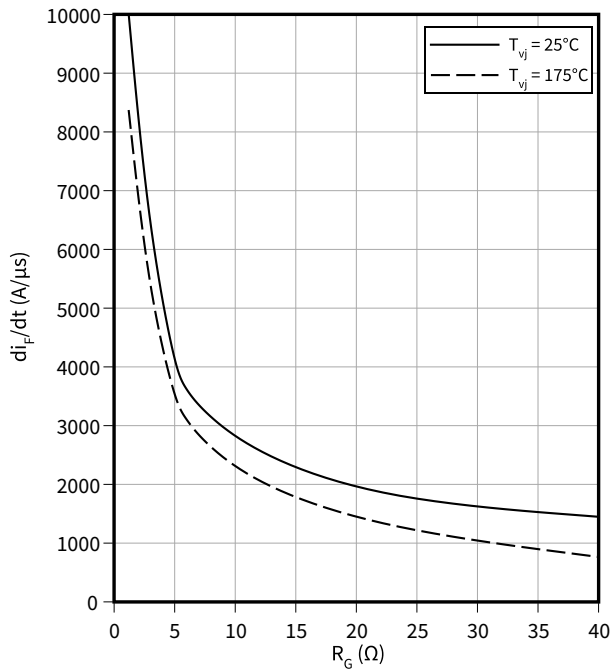


4 Characteristics diagrams

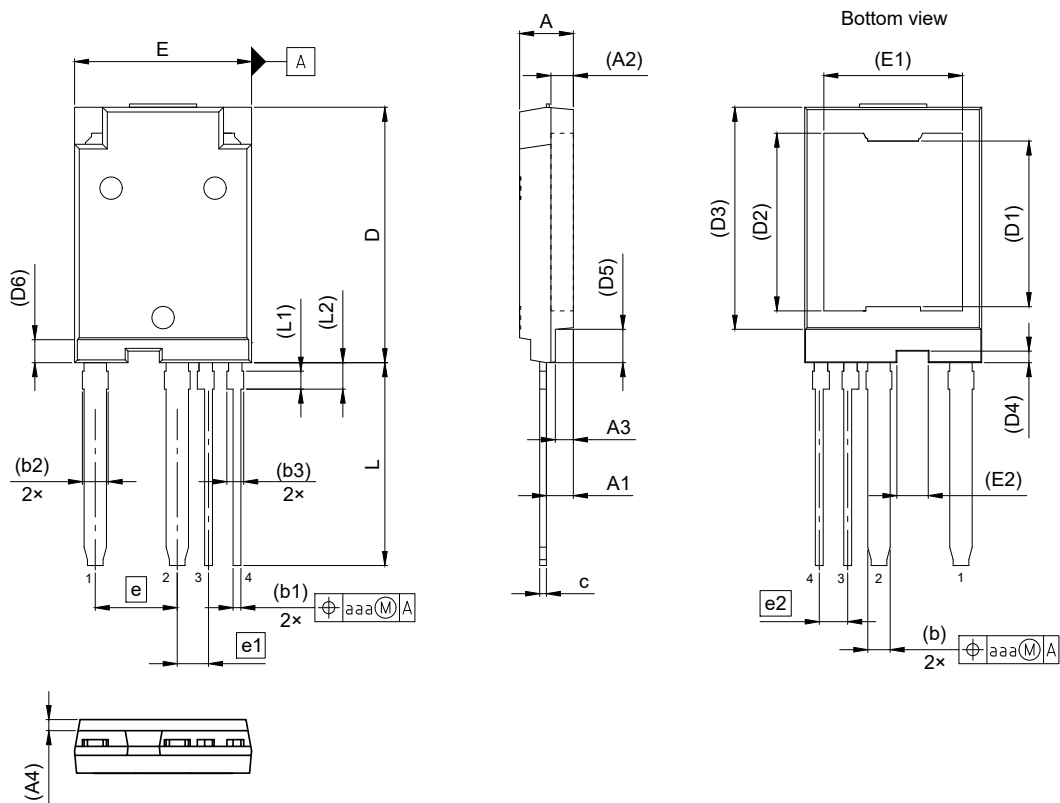
Typical diode current slope as a function of gate resistor

$di_F/dt = f(R_G)$

$V_R = 470\text{ V}, I_F = 160\text{ A}$



5 Package outlines



| PACKAGE - GROUP<br>NUMBER: PG-TO247-4-U06 |             |      |
|-------------------------------------------|-------------|------|
| DIMENSIONS                                | MILLIMETERS |      |
|                                           | MIN.        | MAX. |
| A                                         | 4.7         | 4.9  |
| A1                                        | 2.16        | 2.66 |
| A2                                        | 2           |      |
| A3                                        | 1.51        | 1.71 |
| A4                                        | 0.99        |      |
| b                                         | 2           |      |
| b1                                        | 0.7         |      |
| b2                                        | 2.3         |      |
| b3                                        | 1.5         |      |
| c                                         | 0.5         | 0.7  |
| D                                         | 22.7        | 22.9 |
| D1                                        | 14.79       |      |
| D2                                        | 15.86       |      |
| D3                                        | 19.82       |      |

| DIMENSIONS | MILLIMETERS |       |
|------------|-------------|-------|
|            | MIN.        | MAX.  |
| D4         | 1.03        |       |
| D5         | 2.98        |       |
| D6         | 2.05        |       |
| E          | 15.7        | 15.9  |
| E1         | 12.38       |       |
| E2         | 2.8         |       |
| e          | 7.32        |       |
| e1         | 2.79        |       |
| e2         | 2.54        |       |
| L          | 18.01       | 18.21 |
| L1         | 1.6         |       |
| L2         | 2.36        |       |
| aaa        | 0.25        |       |

1) All metal surfaces tin plated except area of cut  
2) Mold gate protrusion after degating.  
All dimensions are in units mm  
The drawing is in compliance with ISO 128-30, Projection Method 3 [⌀] [A]  
Drawing according to ISO 8015, general tolerances

Figure 1

## 6 Testing conditions

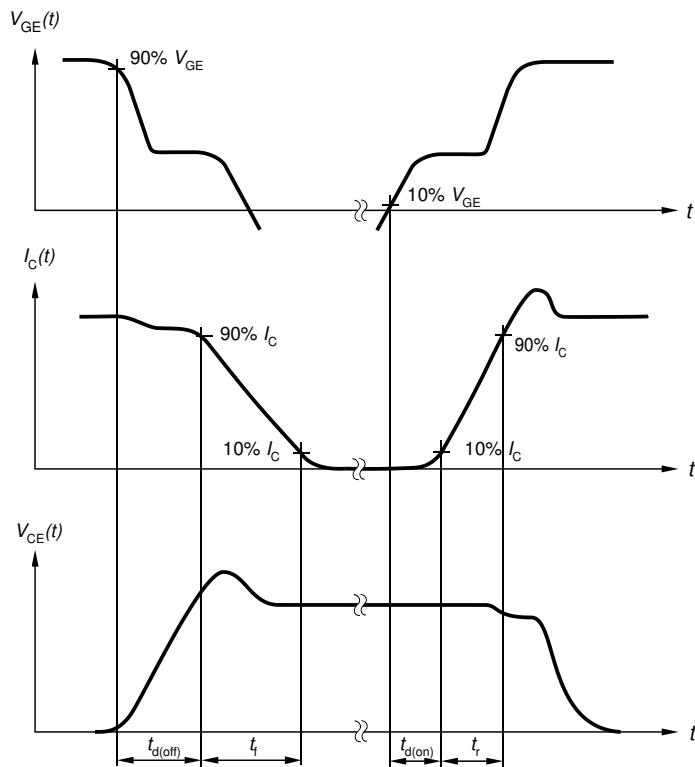


Figure A. Definition of switching times

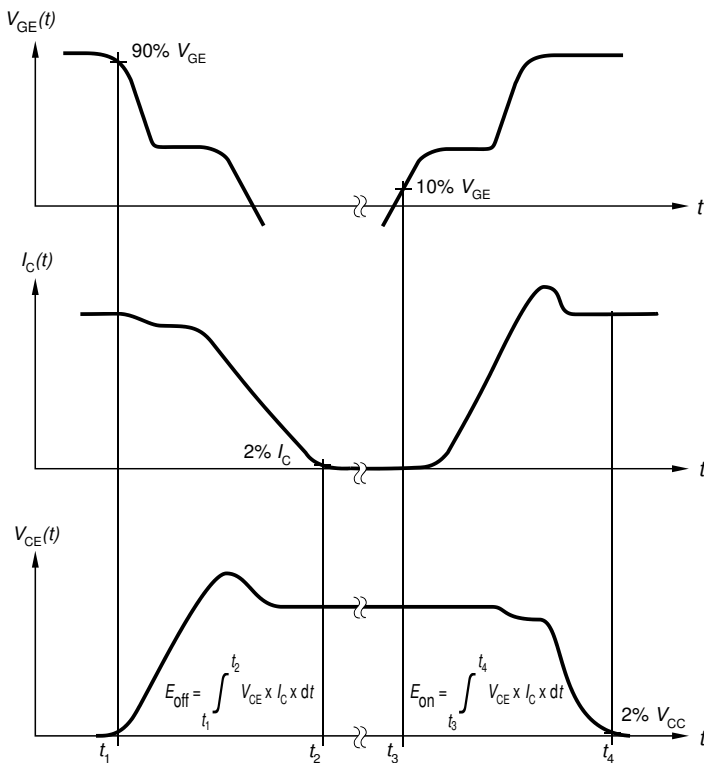


Figure B. Definition of switching losses

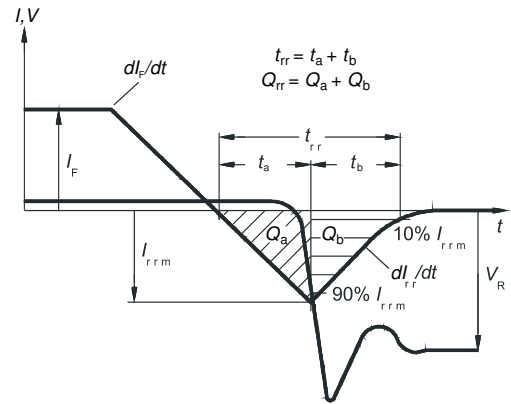


Figure C. Definition of diode switching characteristics

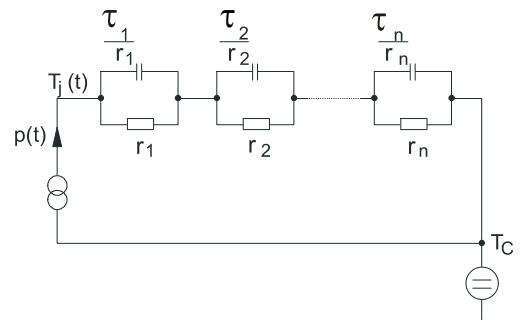


Figure D. Thermal equivalent circuit

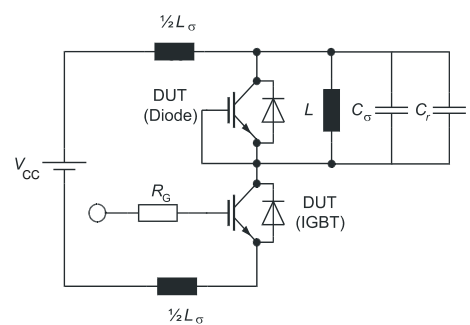


Figure E. **Dynamic test circuit**  
Parasitic inductance  $L_{\sigma}$ ,  
parasitic capacitor  $C_{\sigma}$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)



Revision history

Revision history

| Document revision | Date of release | Description of changes                                          |
|-------------------|-----------------|-----------------------------------------------------------------|
| 0.10              | 2024-03-26      | Preliminary datasheet                                           |
| 1.00              | 2024-07-24      | Final datasheet                                                 |
| 1.10              | 2024-07-29      | Change Output Characteristics graph for 175°C with correct data |

#### Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

**Edition 2024-07-29**

**Published by**

**Infineon Technologies AG**  
**81726 Munich, Germany**

**© 2024 Infineon Technologies AG**  
**All Rights Reserved.**

**Do you have a question about any  
aspect of this document?**

**Email: [erratum@infineon.com](mailto:erratum@infineon.com)**

**Document reference**  
**IFX-ABB842-003**

#### Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenhheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

#### Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.